

BU406, BU407

NPN Power Transistors

These devices are high voltage, high speed transistors for horizontal deflection output stages of TV's and CRT's.

Features

- High Voltage: $V_{CEV} = 330$ or 400 V
- Fast Switching Speed: $t_f = 750$ ns (max)
- Low Saturation Voltage: $V_{CE(sat)} = 1$ V (max) @ 5 A
- Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	BU406 BU407	V_{CEO} 200 150	Vdc
Collector-Emitter Voltage	BU406 BU407	V_{CEV} 400 330	Vdc
Collector-Base Voltage	BU406 BU407	V_{CBO} 400 330	Vdc
Emitter-Base Voltage		V_{EBO} 6	Vdc
Collector Current – Continuous – Peak Repetitive – Peak (10 ms)		I_C 7 10 15	Adc
Base Current		I_B 4	Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C		P_D 60 0.48	W W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Storage		T_J, T_{stg} –65 to 150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.08	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	70	$^\circ\text{C}/\text{W}$
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 5 Seconds	T_L	260	$^\circ\text{C}$

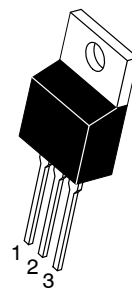
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



ON Semiconductor®

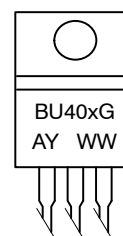
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**NPN SILICON
POWER TRANSISTORS
7 AMPERES – 60 WATTS
150 AND 200 VOLTS**



**TO-220AB
CASE 221A-09
STYLE 1**

MARKING DIAGRAM



BU40x = Specific Device Code
x = 6 or 7
A = Assembly Location
Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
BU406	TO-220AB	50 Units / Rail
BU406G	TO-220AB (Pb-Free)	50 Units / Rail
BU407	TO-220AB	50 Units / Rail
BU407G	TO-220AB (Pb-Free)	50 Units / Rail

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit	
OFF CHARACTERISTICS						
Collector-Emitter Sustaining Voltage (Note 1) ($I_C = 100\text{ mA}$, $I_B = 0$)	BU406 BU407	$V_{CE(sus)}$	200 150	- -	- -	Vdc
Collector Cutoff Current ($V_{CE} = \text{Rated } V_{CEV}$, $V_{BE} = 0$) ($V_{CE} = \text{Rated } V_{CEO} + 50\text{ Vdc}$, $V_{BE} = 0$) ($V_{CE} = \text{Rated } V_{CEO} + 50\text{ Vdc}$, $V_{BE} = 0$, $T_C = 150^\circ\text{C}$)		I_{CES}	- - -	- - -	5 0.1 1	mAdc
Emitter Cutoff Current ($V_{EB} = 6\text{ Vdc}$, $I_C = 0$)	BU406, BU407	I_{EBO}	-	-	1	mAdc

ON CHARACTERISTICS (Note 1)

Collector-Emitter Saturation Voltage ($I_C = 5\text{ Adc}$, $I_B = 0.5\text{ Adc}$)	$V_{CE(sat)}$	-	-	1	Vdc
Base-Emitter Saturation Voltage ($I_C = 5\text{ Adc}$, $I_B = 0.5\text{ Adc}$)	$V_{BE(sat)}$	-	-	1.2	Vdc
Forward Diode Voltage ($I_{EC} = 5\text{ Adc}$) "D" only	V_{EC}	-	-	2	Volts

DYNAMIC CHARACTERISTICS

Current-Gain - Bandwidth Product ($I_C = 0.5\text{ Adc}$, $V_{CE} = 10\text{ Vdc}$, $f_{test} = 20\text{ MHz}$)	f_T	10	-	-	MHz
Output Capacitance ($V_{CB} = 10\text{ Vdc}$, $I_E = 0$, $f = 1\text{ MHz}$)	C_{ob}	-	80	-	pF

SWITCHING CHARACTERISTICS

Inductive Load Crossover Time ($V_{CC} = 40\text{ Vdc}$, $I_C = 5\text{ Adc}$, $I_{B1} = I_{B2} = 0.5\text{ Adc}$, $L = 150\text{ }\mu\text{H}$)	t_c	-	-	0.75	μs
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1. Pulse Test: Pulse Width $\leq 300\text{ }\mu\text{s}$, Duty Cycle $\leq 1\%$.

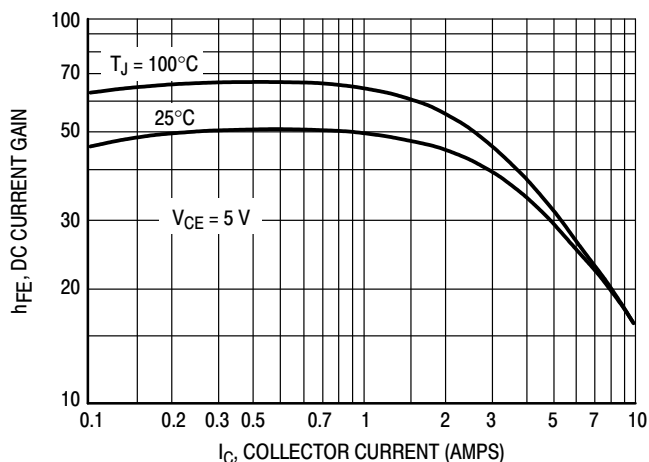


Figure 1. DC Current Gain

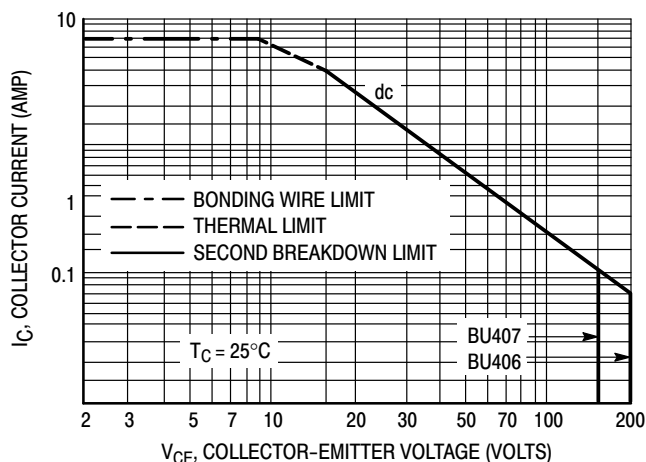
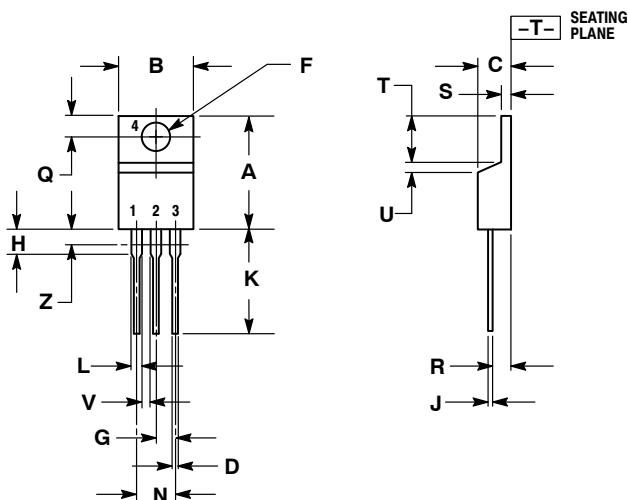


Figure 2. Maximum Rated Forward Bias Safe Operating Area

BU406, BU407

PACKAGE DIMENSIONS

TO-220AB
CASE 221A-09
ISSUE AF



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.014	0.025	0.36	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

STYLE 1:

- PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

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